Unit: mm

TOSHIBA Infrared LED GaAs Infrared Emitter

TLN110(F)

Lead Free Product
Remote-control Systems
Opto-electronic Switches

- High radiant intensity: IE = 30 mW / sr (typ.)
- Excellent radiant—intensity linearity. Modulation by pulse operation and high frequency is possible.
- TPS703(F) PIN photodiode with resin to screen out visible light available as detector for remote control

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Forward current	I _F	100	mA
Forward current derating (Ta > 25°C)	ΔI _F / °C	-1.33	mA / °C
Pulse forward current	I _{FP} (Note)	1	Α
Reverse voltage	V_{R}	5	V
Power dissipation	P _D	150	mW
Operating temperature range	T _{opr}	-20~75	°C
Storage temperature range	T _{stg}	-30~100	°C

(Note): Pulse width ≤ 100µs, repetitive frequency = 100 Hz

2.5 max 1±0.2 (ndude resin build-up) (ndude resin build-up) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5) (1.5)

Weight: 0.32 g (typ.)

TOSHIBA

Pin Connection

Optical And Electrical Characteristics (Ta = 25°C)



Anode
 Cathode

4-6C4

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F	I _F = 100mA	_	1.35	1.5	٧
Reverse current	I _R	V _R = 5V	_	_	10	μA
Radiant intensity	Ι _Ε	I _F = 50mA	15	30	_	mW / sr
Radiant power	PO	I _F = 50mA	_	9	_	mW
Capacitance	C _T	V _R = 0, f = 1MHz	_	20	_	pF
Peak emission wavelength	λ _P	I _F = 50mA	_	940	_	nm
Spectral line half width	Δλ	I _F = 50mA		45	_	nm
Half value angle	$\theta \frac{1}{2}$	I _F = 50mA	_	±8	_	٥

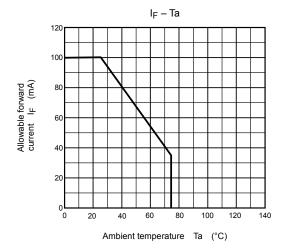
Precautions

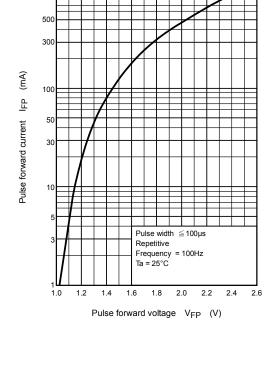
Please be careful of the followings.

- Soldering temperature: 260°C max
 Soldering time: 5s max
 (Soldering must be performed under the stopper.)
- 2. When forming the leads, bend each lead under the 2mm from the body of the device. Soldering must be performed after the leads have been formed.
- 3. Radiant intensity falls over time due to the current which flows in the infrared LED. When designing a circuit, take into account this change in radiant power over time. The ratio of fluctuation in radiation intensity to fluctuation in optical output is 1:1.

$$\frac{I_{E}(t)}{I_{E}(0)} = \frac{P_{O}(t)}{P_{O}(0)}$$

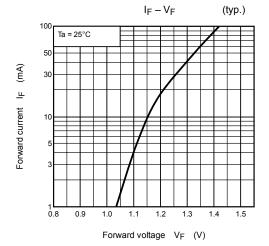
(typ.)

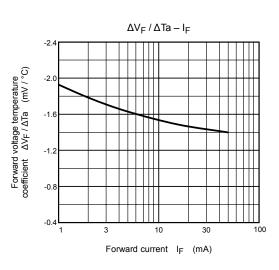


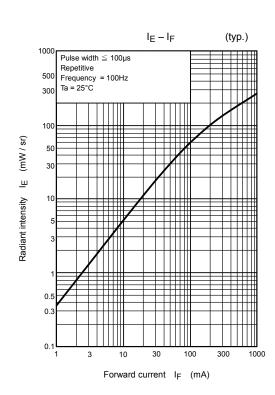


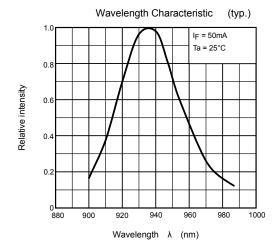
 $\mathsf{I}_{\mathsf{FP}} - \mathsf{V}_{\mathsf{FP}}$

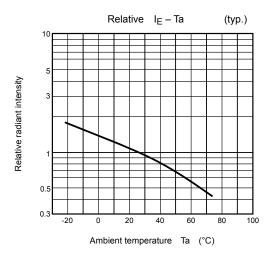
1000





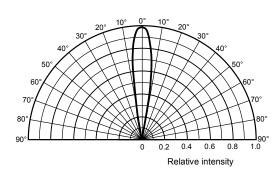


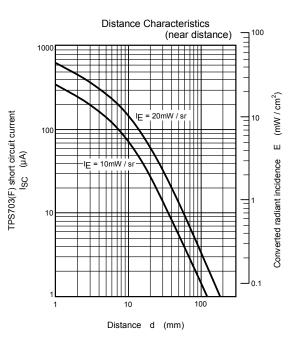


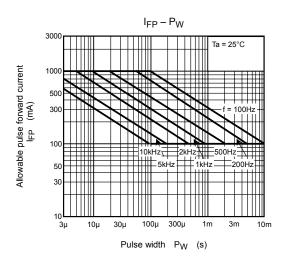


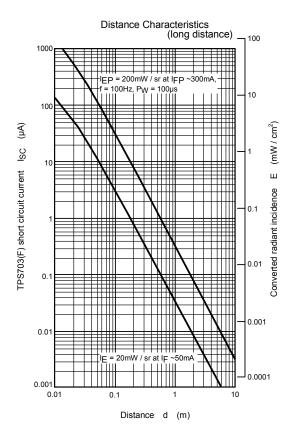
Radiation Pattern (typ.)

(Ta = 25°C)









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